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#### SYSTEM SPECIFICATIONS Panel Size Capacity (Max) 510 x 510 mm (20.0 x 20.0 in.) 50 x 50 mm (2.0 x 2.0 in.) Panel Size Capacity (Min) 110 x 127 x 139 cm System Dimensions (W x D X H) Weight ≈965 kg (2127 lbs.) Maximum panel weight 3.0 kg (6.6 lbs) 0.3 mm to 5.0 mm (0.01 in. to 0.2 in.) **Board Thickness** Board edge clearance (Top) Top: 2.5 mm (0.10 in.); Bottom: 3.0 mm (0.12 in.) Top (above belt): 20.1 mm (0.78 in.); Bottom: 25.4 mm (1.0 in.) Component Clearance (Top) Conveyor Speed Range 150-450 mm/sec (5.9-17.7 in./sec) Conveyor Adjustment Automatic **FUNCTIONAL SPECIFICATIONS** Maximum Inspection Area 508 x 503 mm (20.0 x 19.5 in.) Field-of-View (FOV) 32 x 32 mm (1.26 x 1.26 in.) X and Y Pixel Size @ High Resolution: 15 µm (0.6 mils); High Speed: 30 µm (1.2 mils) 50-500 µm (2-20 mils) Paste Height Range 0.2 µm (0.008 mils) Height Resolution < 2% of PCB diagonals or max. of 6.35mm (0.25 in) total Maximum Board Warp Maximum Pad Size in FOV 15 x 15 mm ( 0.6 x 0.6 in.) Height, Area, Volume, Registration, Bridge Detection, Defect Review Measurement Types Machine Interface SMEMA, RS232 & Ethernet 100-130 / 220-240V (10%), 50/60 Hz, 10-15 amps **Power Requirements** Compressed Air Requirements 5.6 to 7.0 Kgf/cm<sup>2</sup> (80 to 100 psi @ 4 cfm) PERFORMANCE SPECIFICATIONS 108 cm<sup>2</sup>/sec peak (80 cm<sup>2</sup>/sec avg) Inspection Speed @ 30um Inspection Speed @ 15um 56 cm<sup>2</sup>/sec peak (30 cm<sup>2</sup>/sec avg) Fiducial, Barcode and Skip Mark All-in-one scan



### OPTIONS

Gage R&R†

Height Accuracy†

† Under controlled conditions

SPC software, Barcode Readers (1D/2D), Programming Software: ePM-SPI/AOI & GC-PowerPlace, Offline Defect Review, Certification Target

2 µm on a Certification Target

<<5%, 6σ on Printed Circuit Board; <<2%, 6σ on Certification Target

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SE600° 3D SPI

Ultimate Precision Accuracy with World-class Usability

World's Fastest and Most Accurate 3D SPI

www.cyberoptics.com

Specifications subject to change without notice.

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# SE600<sup>™</sup>3D SPI

## Ultimate Precision Accuracy with World-class Usability



- All-new, Standard Dual Illumination Sensor with calibration-free design
- Award-winning Newly Designed Software
- Multi-touch Screen with Intuitive Operation
- Best-in-class Accuracy and Repeatability
- Closed Loop Feedback Ready
- CyberPrint OPTIMIZER™ Ready
- Mounter Feed Forward Ready



## PERFORMANCE AT ITS BEST (ACCURACY AND GR&R)

SE600™ comes with a standard dual illumination sensor designed and built exclusively by CyberOptics. The sensor offers the best repeatability and reproducibility results - even on the smallest paste deposits. The sensor is manufactured as an integrated assembly with absolutely no moving parts - which means no machine-to-machine variation. So, you can be assured that there is no drift over time, no parts to wear and most importantly - no recalibration required.



**Dual Illumination Sensor** 



Scan here to understand why 'True Height Measurement' accuracy is critical for SPI.

## **NEW, AWARD-WINNING INTUITIVE SOFTWARE**

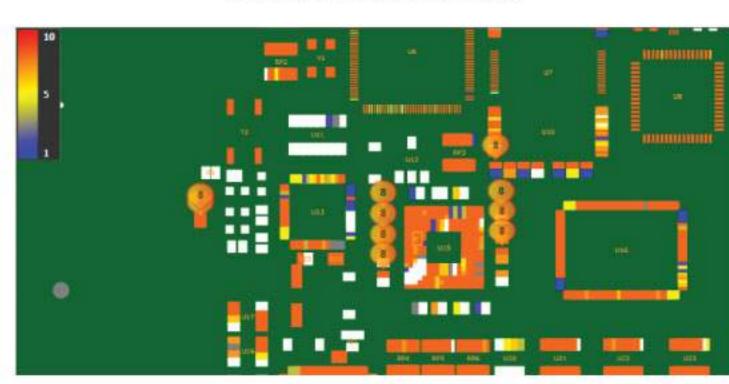
The brand-new V5 series software delivers world-class user experience with its intuitive interface, completely changing the way users interact with our system. Yet, at the same time, the software is extremely stable and simple to use enabling shortest learning curve.

With full multi-touch experience, SPI V5 series software offers a range of revolutionary features that enable smarter and faster inspection:

- Seamless integration of all applications Teach, Inspection, Defect Review and Real-time SPC
- Unlimited undo-redo and global search options in Teach
- Loads of smart, informative and relevant charts that provide yield summary, FPY information, hotspot display, top 10 pad failures, historical panel and more.
- Easy, hassle-free operation using multi-touch, multi-selection, pinch-zoom and pan-move options

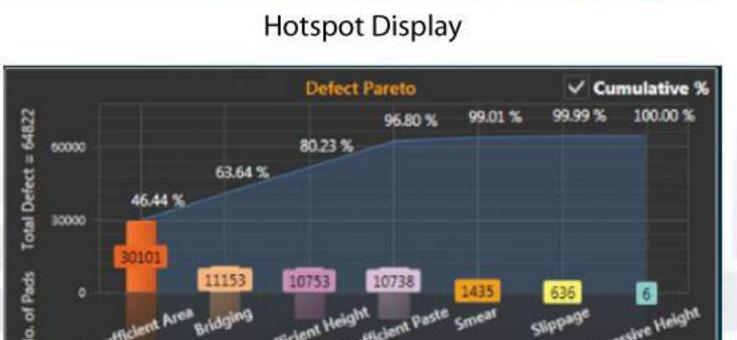


**Defect Review Interface** 





Real-time SPC



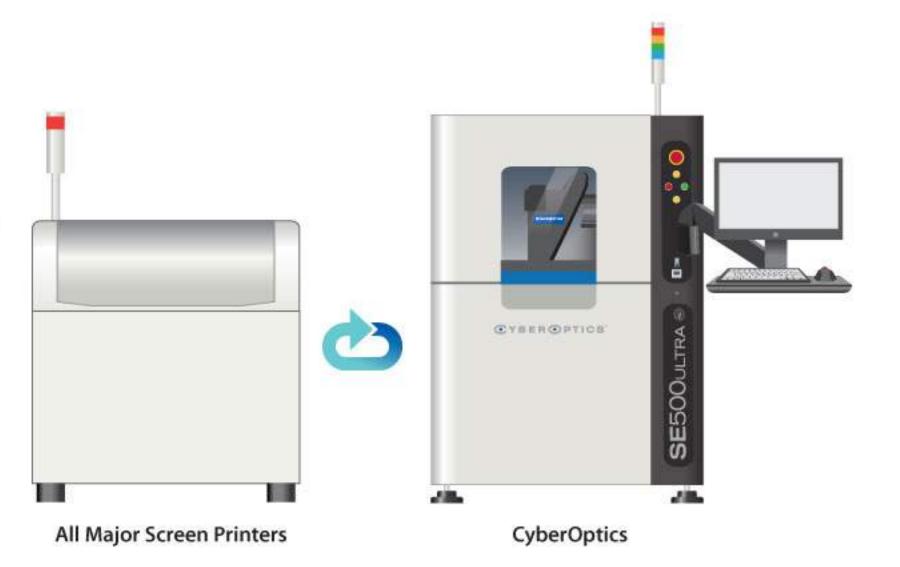
## HIGH SPEED, ON-THE-FLY INSPECTION

SE600™ incorporates CyberOptics' patented 3-D sensing technology that uses white strobe light acquiring full FOVs with each strobe and minimizing vibration effects - delivering good accuracy and consistent repeatability. You can measure ANY PCB surface - including flexible circuits - as white light causes minimum diffusion. With its continuous image acquisition, you can be assured of fast, focused and reliable inspection.

## **3D Solder Paste Measurement System** Optical Triangulation Structured White Light Scanning Technology Best GR&R PERFORMANCE Highest Speed

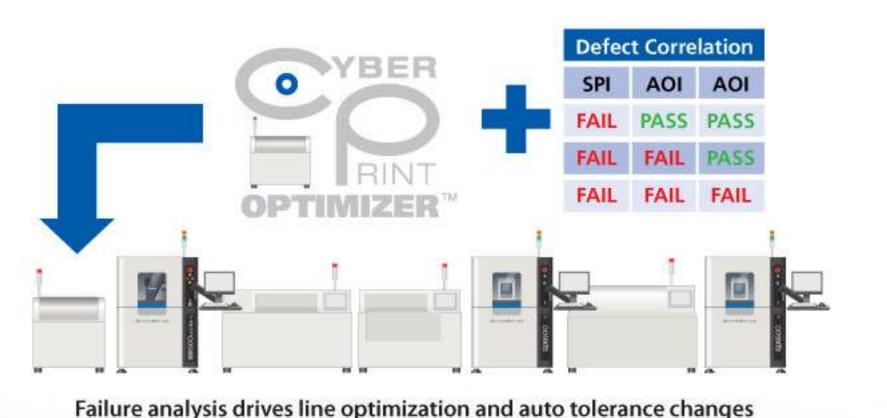
## FEEDBACK, FEED **FORWARD READY**

SE600™ fully supports feedback and feed forward capability with leading Solder Paste Printer and SMT Mounter vendors respectively. With simple configuration settings, SE600™ gives you the power to do more with SPI results - optimize printing process, establish stencil cleaning cycles and fine-tune printer setup. All this means reduced rework costs, increased production throughput and improved yields.



## CYBERPRINT OPTIMIZERTM READY

CyberPrint OPTIMIZER™ automatically optimizes the print process by proactively analyzing accurate trend data – first-ever in the industry! Pre-defined templates help you get started quickly while customizable rules support perfect customization for specific product needs. CyberPrint OPTIMIZER™'s predictive process improvement gets you better yields and reduces downtime.



### **SMART PROCESS CONTROL**

CyberOptics™ offers a full range of historical data analysis tools with drill-down capability and auto-reporting feature.

